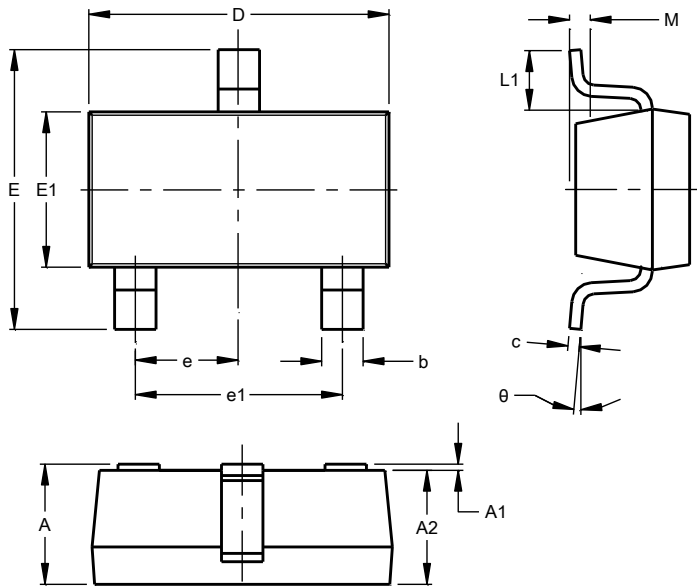


Package Outline Dimensions

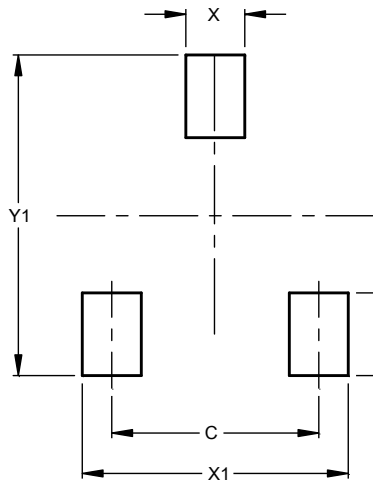
SOT23 (Type BR)



SOT23 (Type BR)			
Dim	Min	Max	Typ
A	--	--	1.450
A1	0.00	0.15	--
A2	0.90	1.30	--
b	0.30	0.50	--
c	0.10	0.20	--
D	2.82	3.10	--
E	2.65	3.00	--
E1	1.500	1.700	--
e	0.950 TYP		
e1	1.80	2.00	--
L1	0.300	0.600	--
M	--	--	0.20
θ	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

SOT23 (Type BR)



Dimensions	Value (in mm)
C	1.900
X	0.570
X1	2.470
Y	0.800
Y1	3.100

ALL DIMENSIONS ARE NOMINAL VALUES SHOWN IN MILLIMETERS

Note: The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application. These numbers may be modified based on user equipment capability or fabrication criteria. A more robust pattern may be desired for wave soldering and is calculated by adding 0.2 mm to the 'Z' dimension. For further information, please reference document IPC-7351A, Naming Convention for Standard SMT Land Patterns, and for International grid details, please see document IEC, Publication 97.